TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74LCX16373AFT**

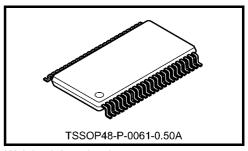
#### Low-Voltage 16-Bit D-Type Latch with 5-V Tolerant Inputs and Outputs

The TC74LCX16373AFT is a high-performance CMOS 16-bit D-type latch. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 16-bit D-type latch is controlled by a latch enable input (LE) and an output enable input ( $\overline{OE}$ ) which are common to each byte. It can be used as two 8-bit latches or one 16-bit latch. When the  $\overline{OE}$  input is high, the outputs are in a high-impedance state.

All inputs are equipped with protection circuits against static discharge.

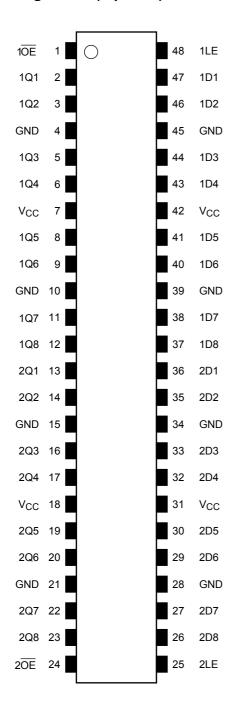


Weight: 0.25 g (typ.)

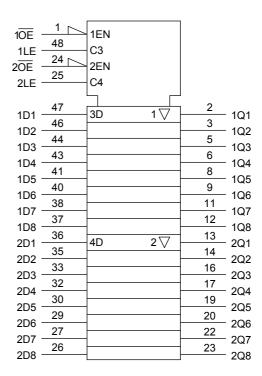
#### **Features**

- Low-voltage operation: V<sub>CC</sub> = 2.0 to 3.6 V
- High-speed operation:  $t_{pd} = 7.0 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Ouput current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- Package: TSSOP
- Power-down protection provided on all inputs and outputs

### Pin Assignment (top view)



### **IEC Logic Symbol**



### **Truth Table**

	Inputs		Outputs
1OE	1LE	1D1-1D8	1Q1-1Q8
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

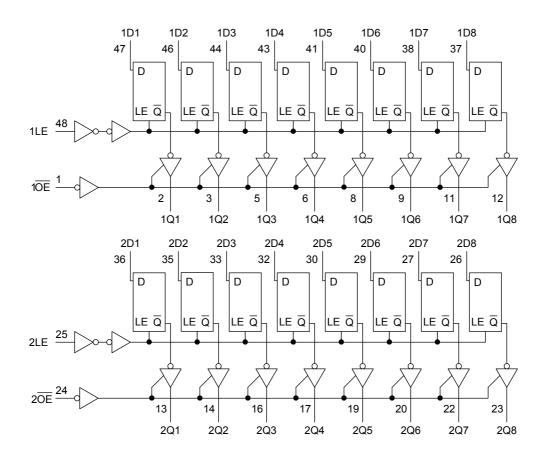
	Outputs		
2 <del>OE</del>	2LE	2D1-2D8	2Q1-2Q8
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level

### **System Diagram**



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### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	$V_{CC}$	-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
Output voltage	$V_{OUT}$	$-0.5$ to $V_{CC}$ + $0.5$	V
		(Note 3)	
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	$P_{D}$	400	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: V<sub>OUT</sub> < GND, V<sub>OUT</sub> > V<sub>CC</sub>

### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6	٧	
Tower suppry voltage	VCC	1.5 to 3.6 (Note 2)		
Input voltage	V <sub>IN</sub>	0 to 5.5	>	
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 3)	>	
		0 to V <sub>CC</sub> (Note 4)		
Output current	I <sub>OH</sub> /I <sub>OI</sub>	±24 (Note 5)	mA	
Output current	iOH/iOL	±12 (Note 6)	Ш	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

## DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteris	stics	Symbol	Test Condition V <sub>CC</sub> (V)		Min	Max	Unit			
	H-level	V <sub>IH</sub>	_		2.7 to 3.6	2.0				
Input voltage	L-level	V <sub>IL</sub>	-	_	2.7 to 3.6	_	0.8	V		
				I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_			
	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>II</sub>	I <sub>OH</sub> = -12 mA	2.7	2.2	_			
				I <sub>OH</sub> = -18 mA	3.0	2.4	_			
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	V		
			$V_{IN} = V_{IH} \text{ or } V_{IL}$ $\frac{I_{OL} = 100  \mu\text{A}}{I_{OL} = 12 \text{ mA}}$ $I_{OL} = 16 \text{ mA}}$ $I_{OL} = 24 \text{ mA}$	$I_{OL} = 100 \mu A$	2.7 to 3.6		0.2			
		.,		I <sub>OL</sub> = 12 mA	2.7		0.4			
	L-level	$V_{OL}$ $V_{IN} = V_{IH}$ or $V_{IL}$		AOF AIM = AIH OI AIF	VIN = VIH OI VIL	I <sub>OL</sub> = 16 mA	3.0	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55			
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		2.7 to 3.6	_	±5.0	μΑ		
3-state output OFF st	ate current	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = 0$ to 5.5 V		2.7 to 3.6	_	±5.0	μА		
Power-off leakage cu	rrent	loff	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0		10.0	μА		
Ouissant sumply sum		$I_{CC} = \frac{V_{IN} = V_{CC} \text{ or GND}}{V_{IN}/V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}}$			V <sub>IN</sub> = V <sub>CC</sub> or GND		_	20.0		
Quiescent supply curr	rent		V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		$V_{IN}/V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$	2.7 to 3.6		±20.0	μΑ	
Increase in Icc per inp	out	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6		500			

# AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition		Min	Max	Unit
Gridiadicriotio	Oymbor		V <sub>CC</sub> (V)	IVIIII	Wax	Offic
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	_	8.0	ns
(D-Q)	$t_{pHL}$	r igure 1, r igure 2	$3.3\pm0.3$	1.5	7.0	115
Propagation delay time	t <sub>pLH</sub>	Figure 1 Figure 2	2.7	_	8.0	ns
(LE-Q)	$t_{pHL}$	Figure 1, Figure 2	$3.3 \pm 0.3$	1.5	7.0	115
2 atata autnut anabla tima	$t_{pZL}$	Figure 1 Figure 2	2.7	_	8.2	ns
3-state output enable time	t <sub>pZH</sub>	Figure 1, Figure 3	$3.3 \pm 0.3$	1.5	7.2	115
2 otato autaut disable time	t <sub>pLZ</sub>	F: 4 F: 0	2.7	_	8.2	no
3-state output disable time	t <sub>pHZ</sub>	Figure 1, Figure 3	$3.3\pm0.3$	1.5	7.2	ns
Minimum pulse width	+ /凵\	Figure 4 Figure 2	2.7	4.0	_	no
(LE)	t <sub>w</sub> (H)	Figure 1, Figure 2	$3.3\pm0.3$	3.0	_	ns
Minimum actus time		Figure 1, Figure 2	2.7	2.5	_	no
Minimum setup time	t <sub>s</sub>		$3.3\pm0.3$	2.5	_	ns
**	4.	Figure 1, Figure 2	2.7	1.5	_	ns
Minimum hold time	t <sub>h</sub>		$3.3\pm0.3$	1.5	_	IIS
Output to output allow	t <sub>osLH</sub>	(Mata)	2.7	_	_	no
Output to output skew	put to output skew (Note)	$3.3\pm0.3$		1.0	ns	

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

### **Dynamic Switching Characteristics**

 $(Ta = 25^{\circ}C, input: t_f = t_f = 2.5 \text{ ns}, C_L = 50 \text{ pF}, R_L = 500 \Omega)$ 

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	٧
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz (Note	3.3	25	pF

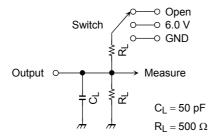
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
$t_{pLZ}$ , $t_{pZL}$	6.0 V
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND
$t_W$ , $t_S$ , $t_h$ ,	Open

Figure 1

### **AC Waveform**

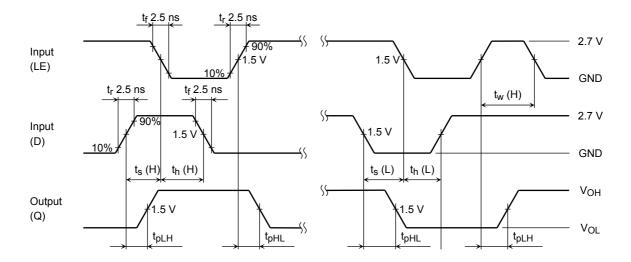


Figure 2  $t_{pLH}, t_{pHL}, t_w, t_s, t_h$ 

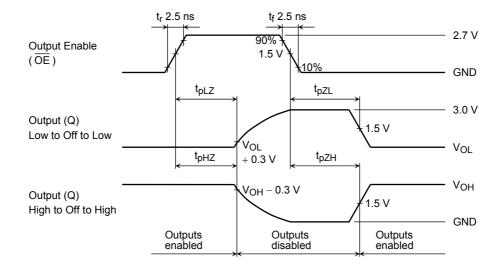
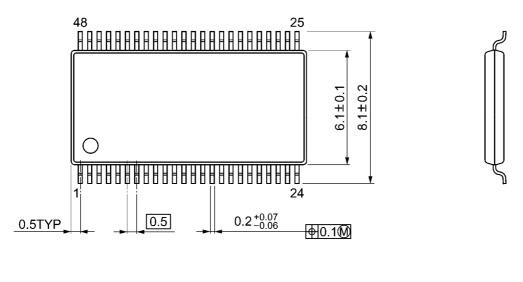
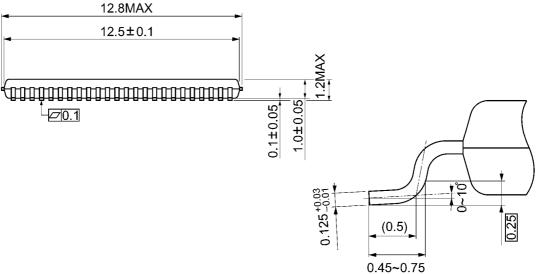


Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

### **Package Dimensions**

TSSOP48-P-0061-0.50A Unit: mm





Weight: 0.25 g (typ.)

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